# imall

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## GA20JT12-247

=

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1200 V

1.4 V

20 A

70 mΩ

 $V_{\text{DS}}$ 

ID

V<sub>DS(ON)</sub>

R<sub>DS(ON)</sub>

### Normally – OFF Silicon Carbide Super Junction Transistor

#### Features

- 175 °C maximum operating temperature
- Temperature independent switching performance
- Gate oxide free SiC switch
- Suitable for connecting an anti-parallel diode
- Positive temperature coefficient for easy paralleling
- Low gate charge
- · Low intrinsic capacitance

#### Package

RoHS Compliant



TO-247AB

#### **Advantages**

- Low switching losses
- Higher efficiency
- High temperature operation
- High short circuit withstand capability

#### Applications

- Down Hole Oil Drilling, Geothermal Instrumentation
- Hybrid Electric Vehicles (HEV)
- Solar Inverters
- Switched-Mode Power Supply (SMPS)
- Power Factor Correction (PFC)
- Induction Heating
- Uninterruptible Power Supply (UPS)
- Motor Drives

#### Maximum Ratings unless otherwise specified

0				
Parameter	Symbol	Conditions	Values	Unit
Drain – Source Voltage	V <sub>DS</sub>	$V_{GS} = 0 V$	1200	V
Continuous Drain Current	I <sub>D</sub>	T <sub>C,MAX</sub> = 95 °C	20	А
Gate Peak Current	I <sub>GM</sub>		10	А
Reverse Gate – Source Voltage	V <sub>SG</sub>		25	V
Reverse Drain – Source Voltage	V <sub>SD</sub>		25	V
Power Dissipation	P <sub>tot</sub>	T <sub>C</sub> = 25 °C	5	W
Storage Temperature	T <sub>stg</sub>		-55 to 175	°C

#### Electrical Characteristics at T<sub>i</sub> = 175 °C, unless otherwise specified

Deverseter	Cumula al	Conditions	Values		11	
Parameter	Symbol	Conditions -	min.	typ.	max.	Unit
On Characteristics						
		I <sub>D</sub> = 20 A, I <sub>G</sub> = 400 mA, T <sub>j</sub> = 25 °C		1.4		
Drain – Source On Voltage	V <sub>DS(ON)</sub>	I <sub>D</sub> = 20 A, I <sub>G</sub> = 800 mA, T <sub>j</sub> = 125 °C		1.6		V
		I <sub>D</sub> = 20 A, I <sub>G</sub> = 1600 mA, T <sub>j</sub> = 175 °C		2.2		
		$I_D = 20 \text{ A}, I_G = 400 \text{ mA}, T_j = 25 \text{ °C}$		70		
Drain – Source On Resistance	R <sub>DS(ON)</sub>	I <sub>D</sub> = 20 A, I <sub>G</sub> = 800 mA, T <sub>i</sub> = 125 °C		80		mΩ
		I <sub>D</sub> = 20 A, I <sub>G</sub> = 1600 mA, T <sub>i</sub> = 175 °C		110		
Cata Fanyard Valtage	1/	I <sub>G</sub> = 500 mA, T <sub>j</sub> = 25 °C		3.3		V
Gate Forward Voltage	$V_{GS(FWD)}$	I <sub>G</sub> = 500 mA, T <sub>j</sub> = 175 °C		3.1		v
DC Current Gain	0	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 20 A, T <sub>i</sub> = 25 °C		TBD		
	β	$V_{DS} = 5 \text{ V}, \text{ I}_{D} = 20 \text{ A}, \text{ T}_{j} = 175 ^{\circ}\text{C}$		TBD		
Off Characteristics						
		V <sub>R</sub> = 1200 V, V <sub>GS</sub> = 0 V, T <sub>i</sub> = 25 °C		1.1		
Drain Leakage Current	IDSS	V <sub>R</sub> = 1200 V, V <sub>GS</sub> = 0 V, T <sub>j</sub> = 125 °C		1.6		μA
0		V <sub>R</sub> = 1200 V, V <sub>GS</sub> = 0 V, T <sub>i</sub> = 175 °C		2.1		•



## GA20JT12-247

Parameter	Symbol	ol Conditions	Values		Unit	
Farameter	Symbol	Conditions	min.	typ.	max.	Uni
Switching Characteristics						
Turn On Delay Time	t <sub>d(on)</sub>			tbd		ns
Rise Time	tr	$V_{DD} = 800 \text{ V}, \text{ I}_{D} = 20 \text{ A},$		tbd		ns
Turn Off Delay Time	t <sub>d(off)</sub>	$R_{G(on)} = R_{G(off)} = 44 \Omega,$ V <sub>GS</sub> = -8/15 V, L = 1.1 mH,		tbd		ns
Fall Time	t <sub>f</sub>	FWD = GB40SLT12,		tbd		ns
Turn-On Energy Per Pulse	Eon	T <sub>j</sub> = 25 °C		tbd		μJ
Turn-Off Energy Per Pulse	E <sub>off</sub>	Refer to Figure 11 for gate current		tbd		μJ
Total Switching Energy	E <sub>ts</sub>	waveform		tbd		μJ
Turn On Delay Time	t <sub>d(on)</sub>			tbd		
Rise Time	tr	$ \begin{array}{c} V_{DD} = 800 \; V, \; I_{D} = 20 \; A, \\ R_{G(on)} = R_{G(off)} = 44 \; \Omega, \\ V_{GS} = -8/15 \; V, \; L = 1.1 \; mH, \\ FWD = GB40SLT12, \\ T_{j} = 175 \; ^{\circ}C \\ \mbox{Refer to Figure 11 for gate current} \end{array} $		tbd		ns
Turn Off Delay Time	t <sub>d(off)</sub>			tbd		ns
Fall Time	t <sub>f</sub>			tbd		ns
Turn-On Energy Per Pulse	Eon			tbd		μJ
Turn-Off Energy Per Pulse	E <sub>off</sub>			tbd		μJ
Total Switching Energy	E <sub>ts</sub>	waveform		tbd		μJ

#### Electrical Characteristics at T<sub>j</sub> = 175 °C, unless otherwise specified

Thermal resistance, junction - case	R <sub>thJC</sub>	1.64	°C/W





Figure 1: Typical Output Characteristics at 25 °C

Figure 2: Typical Output Characteristics at 125 °C







Figure 3: Typical Output Characteristics at 175 °C

Figure 4: Typical Gate Source I-V Characteristics vs. Temperature





Figure 5: Normalized On-Resistance and Current Gain vs. Temperature

Figure 6: Typical Blocking Characteristics

TBD



Figure 7: Typical Hard-switched Turn On Waveforms

Figure 8: Typical Hard-switched Turn Off Waveforms







Figure 9: Typical Turn On Energy Losses and Switching Times vs. Temperature Figure 10: Typical Turn Off Energy Losses and Switching Times vs. Temperature



Figure 11: Typical Gate Current Waveform

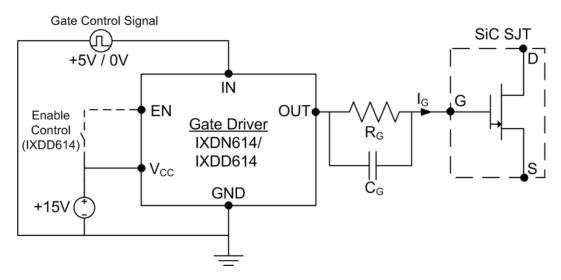


#### Gate Drive Technique (Option #1)

To drive the GA20JT12-247 with the lowest gate drive losses, a custom-designed, dual voltage source gate drive configuration is recommended [for example, see Figure 5(a) in J. Rabkowski et al. IEEE Trans. Power Electronics 27(5), 2633-2642 (2012)]. More details on using this optimized gate drive technique will be made available shortly. An effective simple alternative for ultra-fast switching of the GA20JT12-247 is available below.

#### Gate Drive Technique (Option #2)

The GA20JT12-247 can be effectively driven using the IXYS IXDN614 / IXDD614 non-inverting gate driver IC or a comparable product. A typical gate driver configuration along with component values using this driver is offered below. Additional information is available from the manufacturer at www.ixys.com.



#### Figure 14: Recommended Gate Diver Configuration (Option #2)

Parameter	Querra had	Symbol Conditions	Values			11
	батуз		min.	typ.	max.	Unit
Gate Driver Pins (IXDD614/IXDN614	)					
Supply Voltage	V <sub>cc</sub>		-0.3	15	40	V
Gate Control Input Signal, Low	IN		-5.0	0	0.8	V
Gate Control Input Signal, High	IN		3.0	5.0	V <sub>cc</sub> +0.3	V
Enable, Low	EN	IXDD614 Only			1/3*V <sub>CC</sub>	V
Enable, High	EN	IXDD614 Only	2/3*V <sub>CC</sub>			V
Output Voltage, Low	V <sub>OUT</sub>				0.025	V
Output Voltage, High	V <sub>OUT</sub>		V <sub>CC</sub> -0.025			V
Output Current, Peak	Ι <sub>ουτ</sub>	Package Limited		4.5	14	А
Output Current, Continuous	I <sub>OUT</sub>			0.5	4.0	А
			·			
Passive Gate Components						
Gate Resistance	R <sub>G</sub>	I <sub>G</sub> ≈0.5 A	5	22		Ω

I<sub>G</sub> ≈ 0.5 A

Gate Capacitance

 $C_{G}$ 

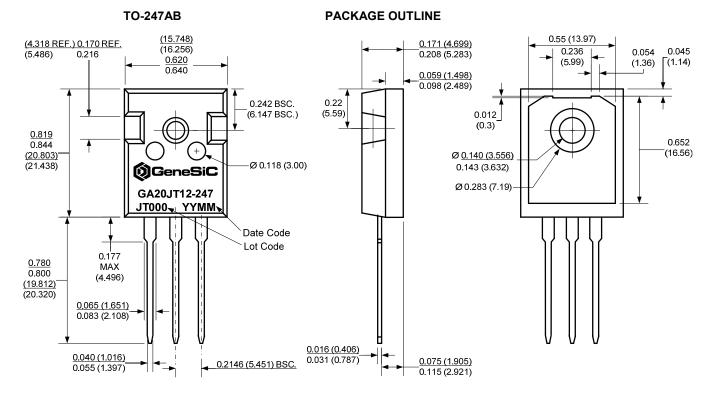
nF

100



## GA20JT12-247

#### **Package Dimensions:**



#### NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.

2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

Revision History						
Date	Revision	Comments	Supersedes			
2013/01/15	0	Initial release				

Published by GeneSiC Semiconductor, Inc. 43670 Trade Center Place Suite 155 Dulles, VA 20166

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